



Product Specification [产品规格书]: Subject [主题]: 3.00mm Pitch 3025 Series Connector Specification	Document No	PS-3025-17
	Date Issued	2017/07/08
	Date Revised	2020/07/18
	Version	B

This specification is referred to the 3.00mm series wire to board connector

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【1.适用范围 Scope】

此种规格包括 3.00mm Pitch 3025 Series 连接器规格说明.

This Specification Covers the 3.00mm Pitch 3025 Series Connector Specification.

【2.规格与料号 Spec and Part number】

规格内容 Specification	产品料号 Production No.
端子/Terminal	3025TF-PXX
胶壳/Housing	3025HM-2*XX-XXXX
针座/Wafer	3025WV-2*XXCE-XXXX

【3.材质与表面处理 Disposal of Material and surface】

规格内容 Specification		材 质 Materials	表面处理 Disposal of Surface
端子/Terminal		磷铜/Phosphor Bronze	Tin Plated: Over 100μ " .Nickel: Over 50μ " . Gold flash or Gold 15u", 30u"
胶壳/Housing		PA66 or PBT	UL 94V-2/UL94V-0
针座/Wafer	Insulation	LCP	UL94V-0
	PIN	黄铜/Brass	Over Matte Tin 100μ " Plated ; Over 50μ " Nickel

(上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】	
额定电压 Rated Voltage (Max.)	250V	[AC/DC]
额定电流 Rated Current (Max.)	5A	
使用温度范围 Ambient temperature Range	-40℃~+105℃	
适用线径 Applicable wire insulation O.D	AWG 20#~24# Insulation O.D. 1.85mm(Max.)	

【 *升温时含端子.Including terminal temperature rise. 】



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【5.性能 PERFORMANCE】

5-1. 电气的性能 Electrical Performance.

项 目 【Item】	条 件 【Test Condition】	规 格 【Requirement】
5-1-1 接触阻抗 Contact Resistance	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 10 milliohms Max. After Test: 20 milliohms Max.
5-1-2 绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用 500V 的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	1000 Megohms Min.
5-1-3 耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用 1000V 的交流电 1 分锺,检测连接器. Mate connectors, apply 1000V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover
5-1-4 铆线后端子接触 阻抗 Contact resistance on crimped portion	铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	5 milliohms Max.



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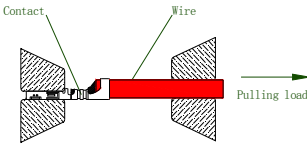
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5-2. 机械的性能 Mechanical Performance.

项 目 【Item】		条 件 【Test Condition】	规 格 【Requirement】
5-2-1	插拔力 Insertion & Retention Force	以每分 25.4±3mm 的速率插入和拔出。 Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	Mating Force: 0.82kgf/ Max./Per PIN Unmating Force: 0.25 Kgf/ Min Per PIN
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量。 Apply axial pull out force at the speed rate of 25.4±3mm/minute on the terminal assembled in the housing.	24.5N {2.5kgf} Min.
5-2-3	端子插入力 Terminal Insertion Force	铆线后之端子插入 Housing 所需最大力量。 Insert the crimped terminal into the housing.	14.7N {1.5kgf} Max.
5-2-4	PIN 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从 Wafer 内轴向拔出的力量。 Apply axial push force at the speed rate of 25.4±3mm/minute.	13.7N {1.4kgf} min.
5-2-5	卡扣保持力 Latch strength	Full mate and then Unmate the connectors at a rate of 25±6mm Per minute	58N {5.9kgf} min.
5-2-6	PIN 插入 PCB 力量 PIN Insertion Force into PCB Hole	Apply an axial insertion force on the terminal at a rate of 25±6mm Per minute	106.7N {10.9kgf} Max.
5-2-7	PIN 拔出 PCB 力量 PIN Fetention Force in PCB Hole	Apply an axial Extraction force on the terminal at a rate of 25±6mm Per minute	27.44N {2.80kgf} Min.



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5-2-8	端子压着强度 Tensile strength (Crimped connections)	固定铆线后的端子, 使电线与端子分离时所需的最小力量.	AWG#	#20	#22	#24
		Fix the crimped terminal, apply axial pull out force on the wire. (Do not crimp insulation part).	Spec.			
			.kgf.	6.0	4.0	2.0
			Min.			
			Note> As for unspecified wire sizes in this specification define values with clients			

5-3. 环境性能及其它 Environmental Performance and Others.

项 目 【Item】		条 件 【Test Condition】	规 格 【Requirement】	
5-3-1	重复插拔 Repeated Insertion/Withdrawal	以每分钟不超过 10 次的速率,将公母插拔 30 次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	20 milliohms Max.
5-3-2	温升测试 Temperature Rise	公母对插后,在通过额定电流下,所测定的温度. Carrying rated current load. (UL 1977)	温升测试 Temperature rise	30°C Max.
5-3-3	耐振动性 Vibration	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute 持续时间: 每轴向 2 小时 Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute Duration: 2 hours in each X.Y.Z axials. (Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	外观 Appearance	无异状 No Damage
			接触阻抗 Contact Resistance	20 milliohms Max.
			瞬断 Discontinuity	1 micro-second Max.
5-3-4	耐冲击性 Shock	在 X.Y.Z 上 6 个方向上,以 490m/s ² (50g 的力量)冲击下各 3 回.490m/s ² {50G}, 3 strokes in each X.Y.Z. axes. (Based upon EIA-364-27B/MIL-STD-202 Method 213B Cond.A)	外观 Appearance	无异状 No Damage
			接触阻抗 Contact Resistance	20 milliohms Max.
			瞬断 Discontinuity	1 micro-second Max.



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5-3-5 耐热性 Heat Resistance	105±2℃, 96 hours. (Based upon MIL-STD-202 Method 108A Cond.A)	外观 Appearance	无异状 No Damage	
		接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-6 耐寒性 Cold Resistance	-40±5℃, 96 hours. (Based upon EIA-364-105)	外观 Appearance	无异状 No Damage	
		接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-7 耐湿性 Humidity	温度: 40±2℃ 湿度: 90~95%(RH) 持续时间: 96 hours Temperature: 40±2℃ Relative Humidity: 90~95% Duration: 96 hours (Based upon EIA-364-31A/MIL-STD-202 Method 103B Cond.B)	外观 Appearance	无异状 No Damage	
		接触阻抗 Contact Resistance	20 milliohms Max.	
		耐电压 Dielectric Strength	Must meet 5-1-3	
		绝缘阻抗 Insulation Resistance	500 Megohms Min.	
5-3-8 温度变化 Temperature Cycling	从-40℃持续 30 分钟升至+105℃持续 30 分钟, 循环 5 次. 5 cycles of: a) -40℃ 30 minutes. b) +105℃ 30 minutes. (Based upon EIA-364-32B)	外观 Appearance	无异状 No Damage	
		接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-9 盐水喷雾 Salt Spray	在温度 35±2℃, 盐水浓度 5±1% 下, 盐水喷雾 24±1 小时. 24±1 hours exposure to a salt spray from the 5±1% solution at 35±2℃. (Based upon EIA-364-26B/MIL-STD-202 Method 101D Cond.B).	外观 Appearance	无异状 No Damage	
		接触阻抗 Contact Resistance	20 milliohms Max.	
5-3-10 焊锡附着性 Solder-ability	焊接时间: 3~5 秒. 焊接温度: 245±5℃. Soldering Time: 3~5second. Solder Temperature: 245±5℃. (Based upon EIA-364-52)	Solder Wetting	浸渍面积需 95%以上 95% of immersed area must show no voids, pin holes.	
5-3-11 焊锡耐热性 Solder-Resistance	焊接时间: 5~10 秒. 焊接温度: 255+2/-2℃. Soldering time: 5~10 sec solder. Temperature: 255+2/-2℃. (Based upon EIA-364-56A)	外观 Appearance	无异状 No Damage	